



P-Channel 150-V (D-S) MOSFET



Product Is Completely Pb-free

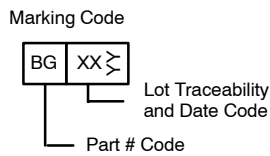
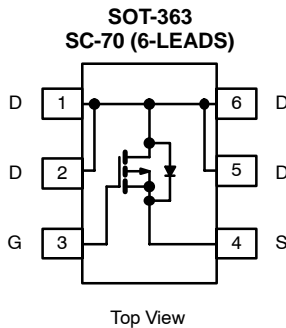
PRODUCT SUMMARY			
V_{DS} (V)	$r_{DS(on)}$ (Ω)	I_D (A)	Q_g (Typ)
-150	2.6 @ $V_{GS} = -10$ V	-0.52	4.2 nC
	2.7 @ $V_{GS} = -6$ V	-0.51	

FEATURES

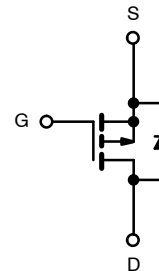
- TrenchFET® Power MOSFETS
- Small, Thermally Enhanced SC-70 Package
- Ultra Low On-Resistance

APPLICATIONS

- Active Clamp Circuits in DC/DC Power Supplies



Ordering Information: Si1411DH-T1—E3



ABSOLUTE MAXIMUM RATINGS ($T_A = 25^\circ\text{C}$ UNLESS OTHERWISE NOTED)					
Parameter	Symbol	5 secs	Steady State	Unit	
Drain-Source Voltage	V_{DS}	-150		V	
Gate-Source Voltage	V_{GS}	± 20			
Continuous Drain Current ($T_J = 150^\circ\text{C}$) ^a	I_D	$T_A = 25^\circ\text{C}$	-0.52	-0.42	A
		$T_A = 85^\circ\text{C}$	-0.38	-0.3	
Pulsed Drain Current	I_{DM}	-0.8			
Continuous Diode Current (Diode Conduction) ^a	I_S	-1.3	-0.83		
Single Pulse Avalanche Current	$L = 0.1$ mH	I_{AS}	-2.1		
Single Pulse Avalanche Energy		E_{AS}	0.22		mJ
Maximum Power Dissipation ^a	P_D	$T_A = 25^\circ\text{C}$	1.56	1.0	W
		$T_A = 85^\circ\text{C}$	0.81	0.52	
Operating Junction and Storage Temperature Range	T_J, T_{stg}	-55 to 150		$^\circ\text{C}$	

THERMAL RESISTANCE RATINGS					
Parameter	Symbol	Typical	Maximum	Unit	
Maximum Junction-to-Ambient ^a	R_{thJA}	$t \leq 5$ sec	60	80	$^\circ\text{C/W}$
		Steady State	100	125	
Maximum Junction-to-Foot (Drain)	R_{thJF}	34	45		

Notes

a. Surface Mounted on 1" x 1" FR4 Board.

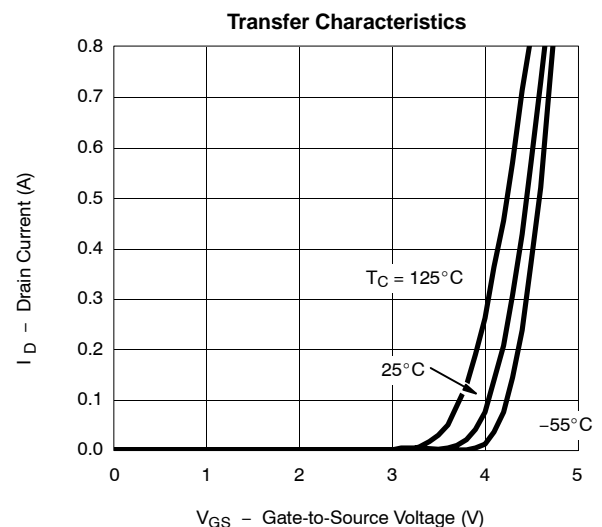
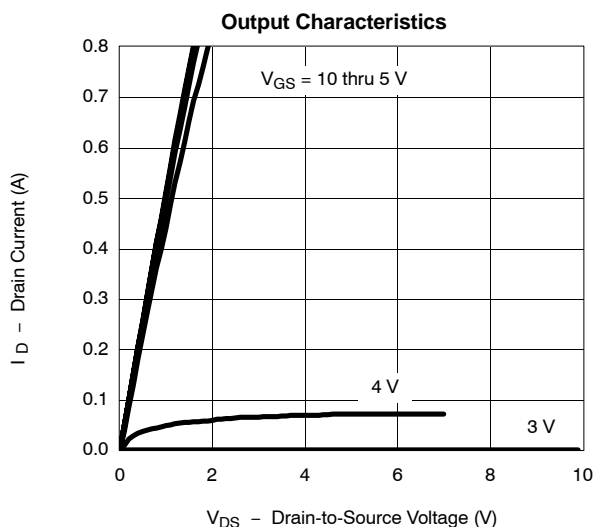
SPECIFICATIONS (T_J = 25 °C UNLESS OTHERWISE NOTED)

Parameter	Symbol	Test Condition	Min	Typ	Max	Unit
Static						
Gate Threshold Voltage	V _{GS(th)}	V _{DS} = V _{GS} , I _D = -100 μA	-2.5		-4.5	V
Gate-Body Leakage	I _{GSS}	V _{DS} = 0 V, V _{GS} = ±20 V			±100	nA
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} = -150 V, V _{GS} = 0 V			-1	μA
		V _{DS} = -150 V, V _{GS} = 0 V, T _J = 85 °C			-5	
On-State Drain Current ^a	I _{D(on)}	V _{DS} = -15 V, V _{GS} = -10 V	-0.8			A
Drain-Source On-State Resistance ^a	r _{DS(on)}	V _{GS} = -10 V, I _D = -0.5 A		2.05	2.6	Ω
		V _{GS} = -6 V, I _D = -0.5 A		2.14	2.7	
Forward Transconductance ^a	g _{fs}	V _{DS} = -10 V, I _D = -0.5 A		1.5		S
Diode Forward Voltage ^a	V _{SD}	I _S = -1.4 A, V _{GS} = 0 V		-0.80	-1.1	V
Dynamic^b						
Total Gate Charge	Q _g	V _{DS} = -75 V, V _{GS} = -10 V, I _D = -0.5 A		4.2	6.3	nC
Gate-Source Charge	Q _{gs}			0.9		
Gate-Drain Charge	Q _{gd}			1.3		
Gate Resistance	R _g	f = 1.0 MHz		8.5		Ω
Turn-On Delay Time	t _{d(on)}	V _{DD} = -75 V, R _L = 75 Ω I _D ≅ -1 A, V _{GEN} = -4.5 V, R _g = 6 Ω		4.5	7	ns
Rise Time	t _r			11	17	
Turn-Off Delay Time	t _{d(off)}			9	14	
Fall Time	t _f			11	17	
Reverse Recovery Time	t _{rr}	I _F = -0.5 A, di/dt = 100 A/μs		36	55	ns
Body Diode Reverse Recovery Charge	Q _{rr}			65	100	

Notes

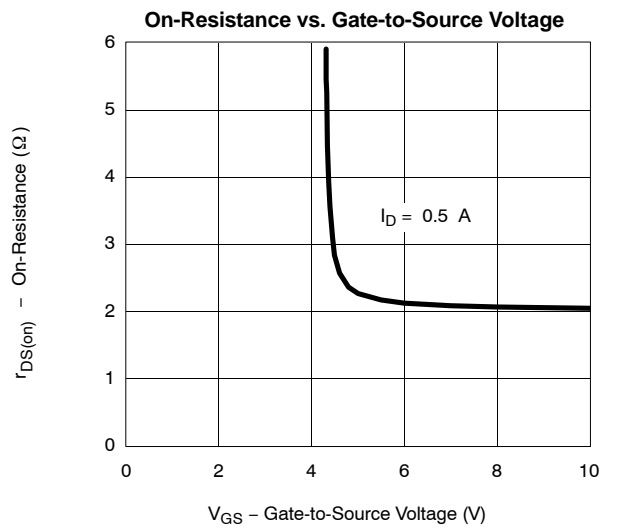
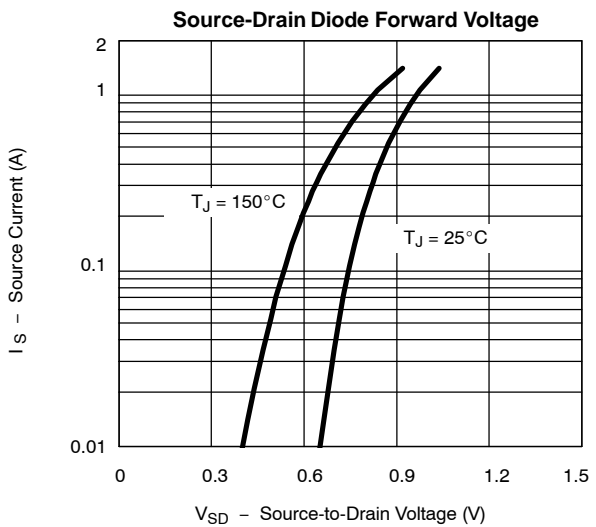
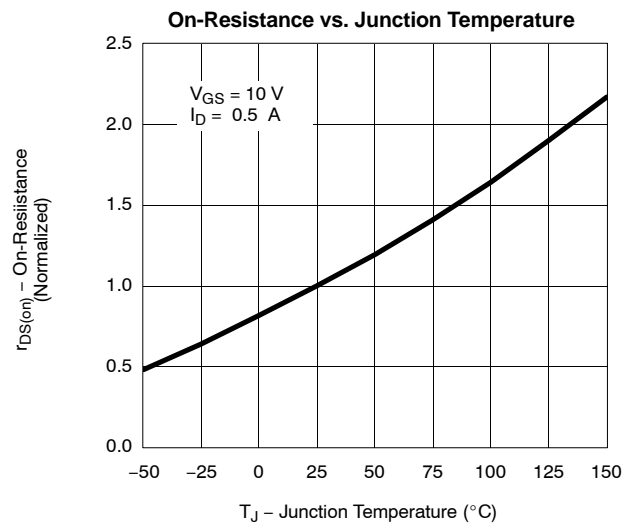
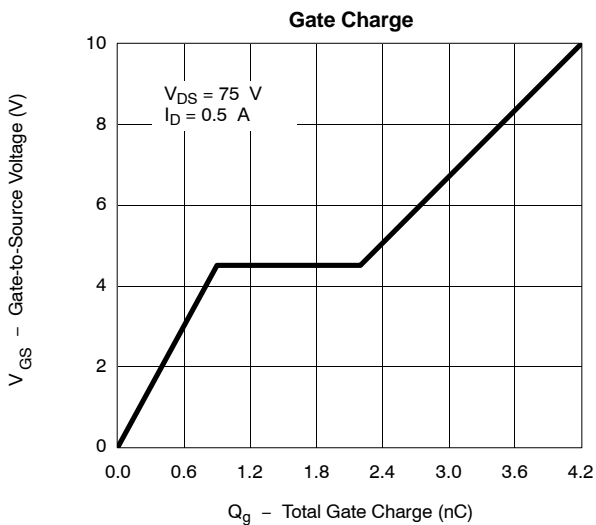
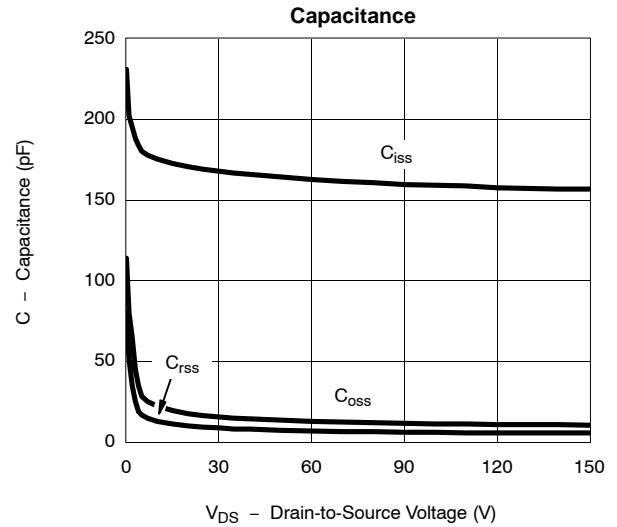
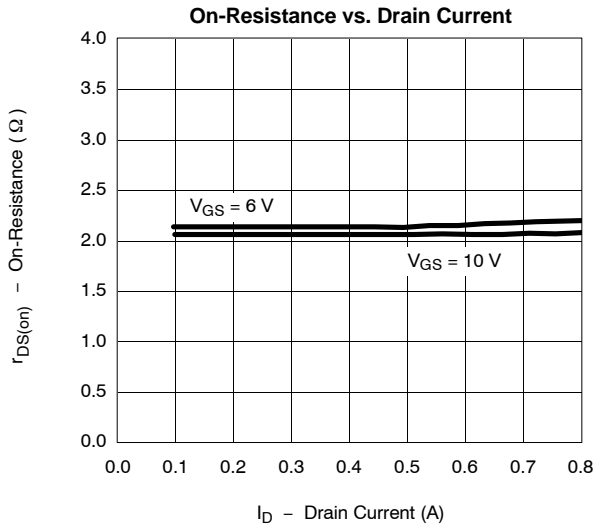
- a. Pulse test; pulse width ≤ 300 μs, duty cycle ≤ 2%.
b. Guaranteed by design, not subject to production testing.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

TYPICAL CHARACTERISTICS (25 °C UNLESS NOTED)

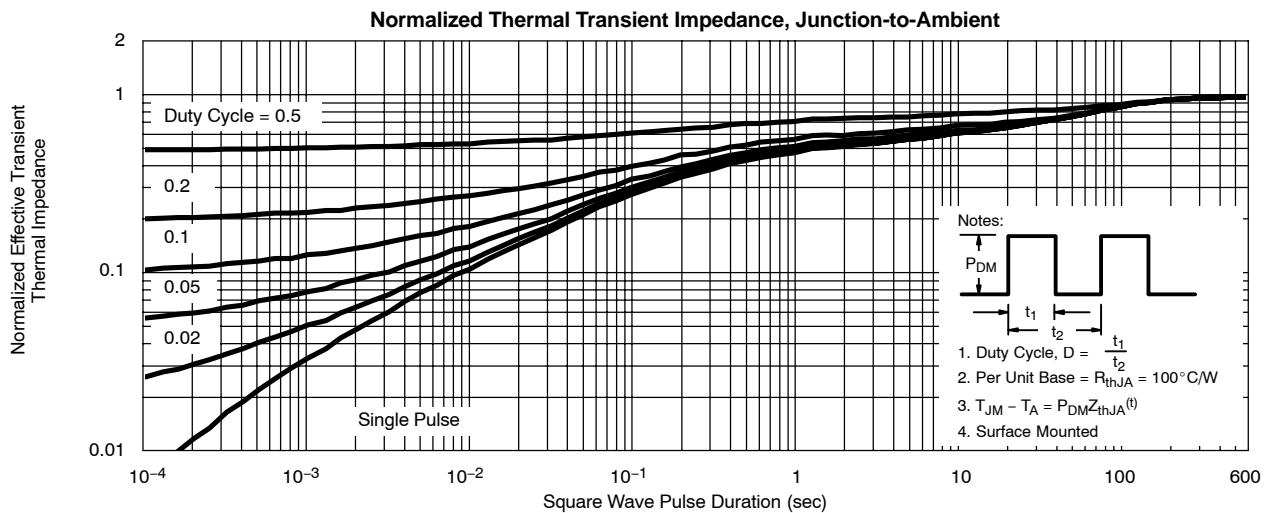
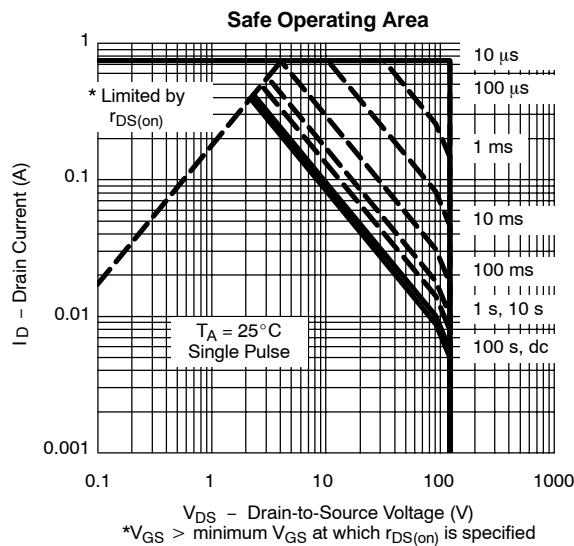
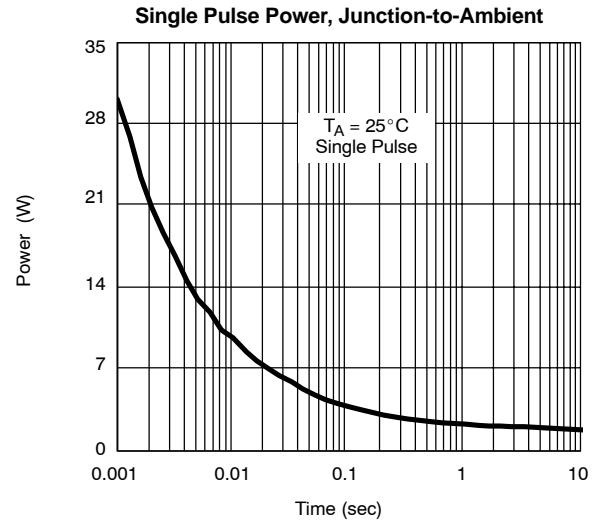
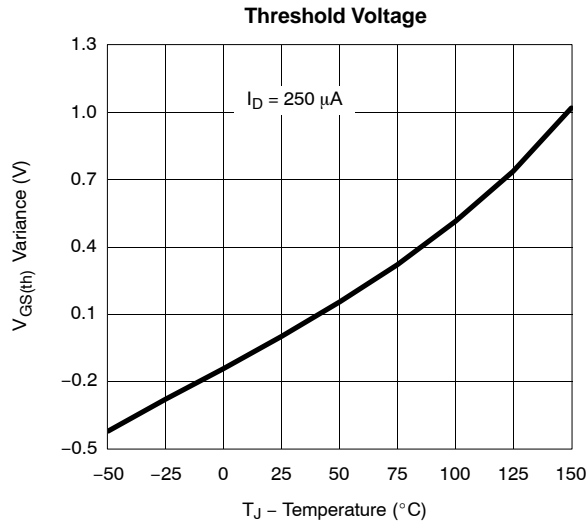


TYPICAL CHARACTERISTICS (25 °C UNLESS NOTED)



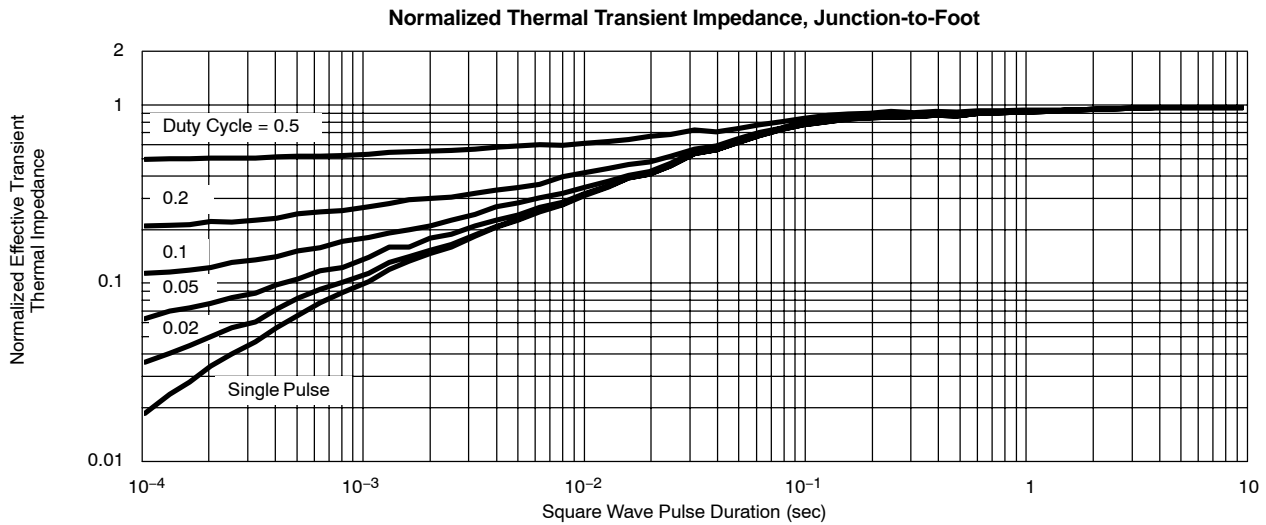


TYPICAL CHARACTERISTICS (25 °C UNLESS NOTED)





TYPICAL CHARACTERISTICS (25 °C UNLESS NOTED)



Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package/tape drawings, part marking, and reliability data, see <http://www.vishay.com/ppg?73242>.



Disclaimer

All product specifications and data are subject to change without notice.

Vishay Intertechnology, Inc., its affiliates, agents, and employees, and all persons acting on its or their behalf (collectively, "Vishay"), disclaim any and all liability for any errors, inaccuracies or incompleteness contained herein or in any other disclosure relating to any product.

Vishay disclaims any and all liability arising out of the use or application of any product described herein or of any information provided herein to the maximum extent permitted by law. The product specifications do not expand or otherwise modify Vishay's terms and conditions of purchase, including but not limited to the warranty expressed therein, which apply to these products.

No license, express or implied, by estoppel or otherwise, to any intellectual property rights is granted by this document or by any conduct of Vishay.

The products shown herein are not designed for use in medical, life-saving, or life-sustaining applications unless otherwise expressly indicated. Customers using or selling Vishay products not expressly indicated for use in such applications do so entirely at their own risk and agree to fully indemnify Vishay for any damages arising or resulting from such use or sale. Please contact authorized Vishay personnel to obtain written terms and conditions regarding products designed for such applications.

Product names and markings noted herein may be trademarks of their respective owners.